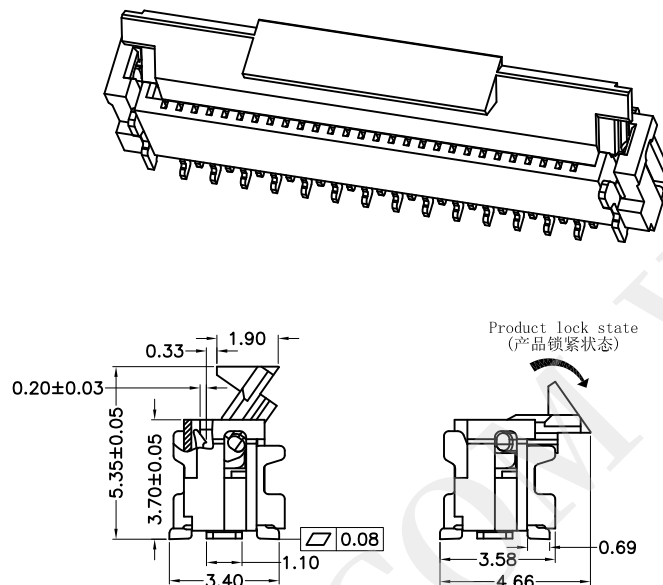
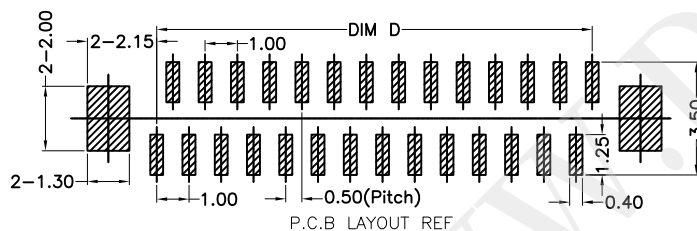
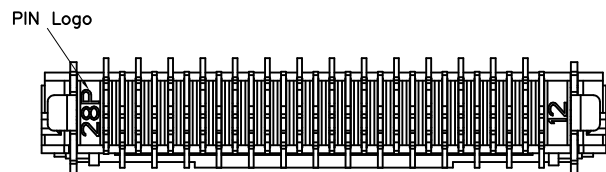
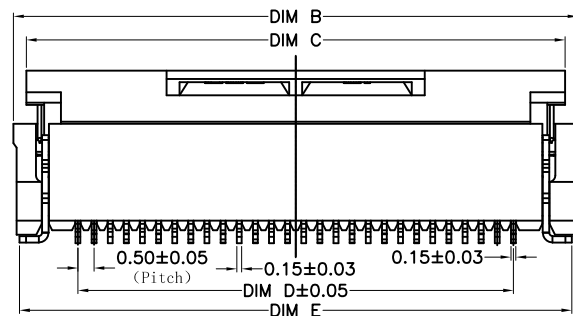
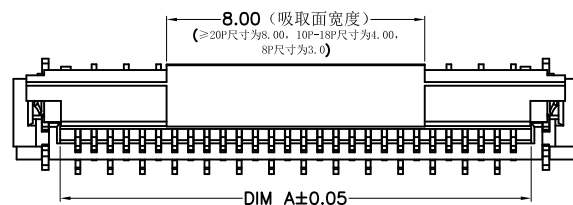


APPLICABLE FPC/FFC
RECOMMENDED DIMENSION
(THICKNESS:0.30±0.03)

60	30.60	33.50	32.70	29.50	33.12
58	29.60	32.50	31.70	28.50	32.12
56	28.60	31.50	30.70	27.50	31.12
54	27.60	30.50	29.70	26.50	30.12
52	26.60	29.50	28.70	25.50	29.12
50	25.60	28.50	27.70	24.50	28.12
48	24.60	27.50	26.70	23.50	27.12
46	23.60	26.50	25.70	22.50	26.12
44	22.60	25.50	24.70	21.50	25.12
42	21.60	24.50	23.70	20.50	24.12
40	20.60	23.50	22.70	19.50	23.12
38	19.60	22.50	21.70	18.50	22.12
36	18.60	21.50	20.70	17.50	21.12
34	17.60	20.50	19.70	16.50	20.12
32	16.60	19.50	18.70	15.50	19.12
30	15.60	18.50	17.70	14.50	18.12
28	14.60	17.50	16.70	13.50	17.12
26	13.60	16.50	15.70	12.50	16.12
24	12.60	15.50	14.70	11.50	15.12
22	11.60	14.50	13.70	10.50	14.12
20	10.60	13.50	12.70	9.50	13.12
18	9.60	12.50	11.70	8.50	12.12
16	8.60	11.50	10.70	7.50	11.12
14	7.60	10.50	9.70	6.50	10.12
12	6.60	9.50	8.70	5.50	9.12
10	5.60	8.50	7.70	4.50	8.12
8	4.60	7.50	6.70	3.50	7.12
6	3.60	6.50	5.70	2.50	6.12
4	2.60	5.50	4.70	1.50	5.12
No. of Contacts	A	B	C	D	E

1.MATERIAL:

- 1.1 HOUSING: High Temperature Plastic,UL94V-0; COLOR: BLACK.
- 1.2 ACTUATOR: High Temperature Plastic,UL94V-0; COLOR: BLACK.
- 1.3 CONTACT: Copper alloy,T=0.15±0.01mm
- 1.4 SOLDER PAD: Copper alloy,T=0.20±0.01mm

2.FINISH:

- 2.1 CONTACT:TIN PLATED IN SOLDER AREA
NICKEL UNDERPLATED OVERALL.
- 2.2 SOLDER PAD:TIN PLATED IN SOLDER AREA
NICKEL UNDERPLATED OVERALL.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.5PH 5.4H 掀盖立式正脚FPC
UNIT: mm [inch] SCALE:1:1 SIZE: A4	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC3CE1-05FPCXX-540
	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HYC-2609081121
			SHEET NO. 1 OF 1